

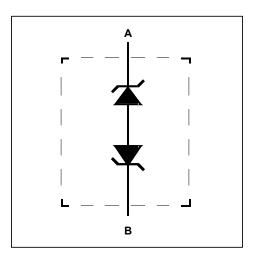
# 1-Channel ESD Protection Device in 0201 CSP

CM1242-33CP

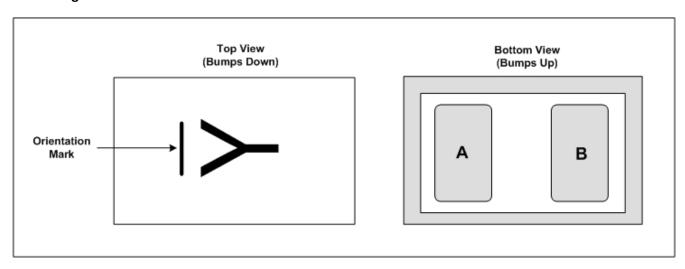
### **Functional Description**

The CM1242-33CP is a 2-bump ESD protection device in 0201 CSP form factor. It is fully compliant with IEC 61000-4-2. The CM1242-33CP is also RoHS II compliant and has a pure tin finish.

### **Electrical Schematic**



### **Pin Configurations**



### **Pin Descriptions**

PIN	DESCRIPTION
А	ESD Channel Pin 1
В	ESD Channel Pin 2

### **Ordering Information**

Bumps	Package	Ordering Part Number <sup>1</sup>	Part Marking	
2	CSP	CM1242-33CP	Υ	

Note 1: Parts are shipped in Tape and Reel form.

### **Operating Conditions**

PARAMETER	RATING	UNITS
Storage Temperature Range	-55 to +150	℃
Operating Temperature Range	-40 to +85	℃
Maximum Input Voltage	±5.5	V

## CM1242-33CP

### **Electrical Operating Characteristics (see Note 1)**

SYMBOL	PARAMETER	CONDITIONS	MIN	ТҮР	MAX	UNITS
V <sub>B</sub>	Breakdown Voltage	$I_F = +10\text{mA}$ $I_F = -10\text{mA}$	6.0 -9.0	7.6 -7.6	9.0 -6.0	V V
I <sub>LEAK</sub>	Channel Leakage Current	$V_{IN} = \pm 3V$		±0.1	±0.50	μА
C <sub>IN</sub>	Channel Input Capacitance	At 1 MHz, V <sub>IN</sub> =0V	45	55	66	pF
V <sub>ESD</sub>	ESD Protection Peak Discharge Voltage at any channel input a) Contact discharge per IEC 61000-4-2 standard b) Air discharge per IEC 61000-4-2 standard	Note 2	±30 ±30			kV kV
V <sub>CL</sub>	Channel Clamp Voltage Positive Transients Negative Transients	$I_{PP} = 1A, t_P = 8/20 \mu s$		+8.6 -8.6		V V
R <sub>DYN</sub>	Dynamic Resistance Positive Transients Negative Transients	$I_{PP} = 1A$ , $t_P = 8/20 \mu s$		0.4 0.4		Ω

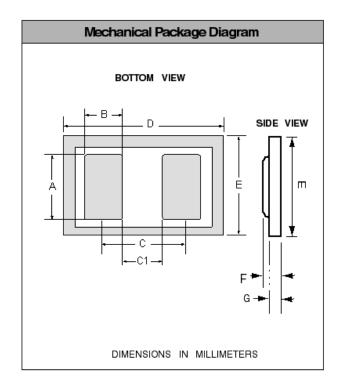
Note 1:  $T_A=25$  °C unless otherwise specified.

Note 2: Standard IEC 61000-4-2 with  $C_{\text{Discharge}} = 150 \text{pF}$ ,  $R_{\text{Discharge}} = 330 \Omega$ .

### **CM1242-33CP Mechanical Specifications**

The CM1242-33CP is supplied in a 2-bump Chip Scale Package (CSP).

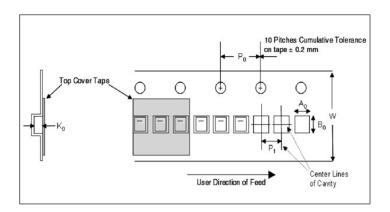
Package Specifications								
Pack	age	Custom CSP						
Bum	nps	2						
Dim	M	lillimete	ers	Inches				
	Min	Nom	Max	Min	Nom	Max		
Α	0.195	0.215	0.235	0.00768	0.00846	0.00925		
В	0.140	0.155	0.170	0.0055	0.0061	0.0067		
С	0.360 REF			0.01417 REF				
C1	0.190	0.205	0.220	0.00748	0.00866			
D	0.570	0.600	0.630	0.02244	0.02362	0.02480		
E	0.270	0.300	0.330	0.01063	0.01181	0.01299		
F	0.250	0.275	0.300	0.00984	0.01083	0.01181		
G	0.240	0.265	0.290	0.00945	0.01043	0.01142		
Controlling dimension: millimeters								



CM1242-33CP Chip Scale Package

### **CSP Tape and Reel Specifications**

PART NUMBER	CHIP SIZE (mm)	POCKET SIZE (mm) B <sub>o</sub> X A <sub>o</sub> X K <sub>o</sub>	TAPE WIDTH W	REEL DIAMETER	QTY PER REEL	P <sub>o</sub>	P <sub>1</sub>
CM1242-33CP	0.600 X 0.300 X 0.275	0.67 x 0.37 x 0.35	8mm	178mm (7")	15,000	4mm	2mm



**Tape and Reel Mechanical Data** 

### CM1242-33CP

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